# XS1-G04B-FB512 Datasheet



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## 1 Features

### ▶ Quad-Tile Multicore Microcontroller with Advanced Multi-Core RISC Architecture

- Up to 1600 MIPS shared between up to 32 real-time logical cores
- Each logical core has:
  - Guaranteed throughput of between 1/4 and 1/8 of tile MIPS
  - 16x32bit dedicated registers
- 159 high-density 16/32-bit instructions
  - All have single clock-cycle execution (except for divide)
  - 32x32-64-bit MAC instructions for DSP, arithmetic and user-definable cryptographic functions

### ► Programmable I/O

- 256 general-purpose I/O pins, configurable as input or output
- Port sampling rates of up to 60 MHz with respect to an external clock
- 128 channel ends for communication with other cores, on or off-chip

#### **▶** Memorv

- 256KB internal single-cycle SRAM (max 64KB per tile) for code and data storage
- 32KB internal OTP (max 8KB per tile) for application boot code

### ▶ JTAG Module for On-Chip Debug

### ▶ Security Features

- · Programming lock disables debug and prevents read-back of memory contents
- AES bootloader ensures secrecy of IP held on external flash memory

## ► Ambient Temperature Range

Commercial qualification: 0°C to 70°C
 Industrial qualification: -40°C to 85°C

#### ▶ Speed Grade

- 400 MHz part: 400 MIPS
- ▶ 512-pin PBGA package 0.8 mm pitch



# 2 Pin Configuration

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24
Α	IO VDD	IO VDD	X0D61	X0D63	X0D65	VSS	X0D67	X0D69	NC	IO VDD	NC	NC	NC	NC	VSS	NC	X3D69	X3D67	IO VDD	X3D65	X3D63	X3D61	VSS	VSS
В	IO VDD	IO VDD	NC	X0D62	X0D64	VSS	X0D66	X0D68	X0D70	IO VDD	NC	NC	NC	NC	VSS	X3D70	X3D68	X3D66	IO VDD	X3D64	X3D62	NC	VSS	VSS
С	NC	X0D58	IO VDD	X0D37	X0D39	X0D41	VSS	X0D43	NC	NC	IO VDD	NC	NC	VSS	NC	NC	X3D43	IO VDD	X3D41	X3D39	X3D37	VSS	X3D58	NC
D	X0D57	X0D56	X0D35	IO VDD	X0D36	X0D38	X0D40	VSS	X0D42	NC	NC	NC	NC	NC	NC	X3D42	IO VDD	X3D40	X3D38	X3D36	vss	X3D35	X3D56	X3D57
Е	X0D55	X0D54	X0D33	X0D34	IO VDD	X0D13	X0D15	X0D17	VSS	X0D19	X0D21	X0D23	X3D23	X3D21	X3D19	IO VDD	X3D17	X3D15	X3D13	VSS	X3D34	X3D33	X3D54	X3D55
F	VSS	VSS	X0D31	X0D32	X0D11	IO VDD	X0D12	X0D14	X0D16	X0D18	X0D20	X0D22	X3D22	X3D20	X3D18	X3D16	X3D14	X3D12	vss	X3D11	X3D32	X3D31	IO VDD	IO VDD
G	X0D53	X0D52	VSS	X0D30	X0D09	X0D10	IO VDD	SS_PLL_ BYPASS	SS_ BYPASS_ PLL_ LOCK	VDD	VDD	SS_ RESET	SS_OTP_ VREF	VDD	VDD	VDD	SS_OTP_ PWR_UP	VSS	X3D10	X3D09	X3D30	IO VDD	X3D52	X3D53
Н	X0D51	X0D50	X0D29	VSS	X0D07	X0D08	SS_CLK											SS_XCO_ BS[0]	X3D08	X3D07	IO VDD	X3D29	X3D50	X3D51
J	X0D49	NC	X0D27	X0D28	VSS	X0D06	SS_PLL_ LOCK											SS_XCO_ BS[1]	X3D06	IO VDD	X3D28	X3D27	NC	X3D49
К	IO VDD	IO VDD	X0D25	X0D26	X0D05	X0D04	VDD			VSS	VSS	VSS	VSS	VSS	VSS			VDD	X3D04	X3D05	X3D26	X3D25	VSS	VSS
L	NC	NC	IO VDD	X0D24	X0D03	X0D02	VDD			VSS	VSS	VSS	VSS	VSS	VSS			VDD	X3D02	X3D03	X3D24	NC	SS_XC_ CFG[0]	SS_XC1_ BS[0]
М	NC	NC	NC	NC	X0D01	X0D00	SS_EXT_ OSC_ CONFIG			VSS	VSS	VSS	VSS	VSS	VSS			SS_ DEBUG	X3D00	X3D01	NC	NC	SS_XC_ CFG[1]	SS_XC1_ BS[1]
N	NC	NC	NC	NC	X1D01	X1D00	SS_EXT_ OSC_ HS_ MODE			VSS	VSS	VSS	VSS	VSS	VSS			SS_ RESERVEE	X2D00	X2D01	NC	NC	SS_XCO_ BS[2]	SS_XC1_ BS[2]
Р	NC	NC	VSS	X1D24	X1D03	X1D02	VDD			VSS	VSS	VSS	VSS	VSS	VSS			VDD	X2D02	X2D03	X2D24	NC	SS_XCO_ BS[3]	SS_XC1_ BS[3]
R	VSS	VSS	X1D25	X1D26	X1D05	X1D04	VDD			VSS	VSS	VSS	VSS	VSS	VSS			VDD	X2D04	X2D05	X2D26	X2D25	IO VDD	IO VDD
Т	X1D49	NC	X1D27	X1D28	IO VDD	X1D06	SS_PLL_ TEST											SS_ TEST_ ENA	X2D06	VSS	X2D28	X2D27	NC	X2D49
U	X1D51	X1D50	X1D29	IO VDD	X1 D07	X1D08	SS_PLL_ AGND											SS_TCK	X2D08	X2D07	VSS	X2D29	X2D50	X2D51
٧	X1D53	X1D52	IO VDD	X1D30	X1D09	X1D10	VSS	SS_PLL_ AVDD	SS_OTP_ VPP	VDD	VDD	SS_TMS	SS_TDO	VDD	VDD	SS_TDI	SS_TRST	IO VDD	X2D10	X2D09	X2D30	VSS	X2D52	X2D53
w	IO VDD	IO VDD	X1D31	X1D32	XIDII	VSS	X1D12	XID14	XID16	XID18	X1D20	X1D22	X2D22	X2D20	X2D18	X2D16	X2D14	X2D12	IO VDD	X2D11	X2D32	X2D31	VSS	VSS
Υ	X1D55	X1D54	X1D33	X1D34	VSS	X1D13	XID15	X1D17	IO VDD	XID19	X1D21	X1D23	X2D23	X2D21	X2D19	VSS	X2D17	X2D15	X2D13	IO VDD	X2D34	X2D33	X2D54	X2D55
AA	X1D57	X1D56	X1D35	VSS	X1D36	X1D38	X1D40	IO VDD	X1D42	NC	NC	NC	NC	NC	NC	X2D42	VSS	X2D40	X2D38	X2D36	IO VDD	X2D35	X2D56	X2D57
AB	NC	X1D58	VSS	X1D37	X1D39	X1D41	IO VDD	X1D43	NC	NC	VSS	NC	NC	IO VDD	NC	NC	X2D43	VSS	X2D41	X2D39	X2D37	IO VDD	X2D58	NC
AC	VSS	VSS	NC	X1D62	X1D64	IO VDD	X1D66	X1D68	X1D70	VSS	NC	NC	NC	NC	IO VDD	X2D70	X2D68	X2D66	VSS	X2D64	X2D62	NC	IO VDD	IO VDD
AD	VSS	VSS	X1D61	X1D63	X1D65	IO VDD	X1D67	X1D69	NC	VSS	NC	NC	NC	NC	IO VDD	NC	X2D69	X2D67	VSS	X2D65	X2D63	X2D61	IO VDD	IO VDD



# 3 Signal Description

Module	Signal	Function	Type	Active	Properties
	PU=Pull I	Jp, PD=Pull Down, ST=Schmitt Trigger Input	, OT=Outp	ut Tristate,	S=Switchable
		$R_S$ =Required for SPI boot (§5.6), $R_U$ =Requ	uired for U	SB-enabled	devices (§10)
	VSS	Digital ground	GND	_	
	VDD	Digital tile power	PWR	_	
	IO VDD	Digital I/O power	PWR	_	
Power	SS_PLL_AGND	Analog ground for PLL	GND	_	
	SS_PLL_AVDD	Analog PLL power	PWR	_	
	SS_OTP_VPP	OTP programming voltage	PWR	_	
	SS_RESET	Global reset input	Input	_	
	SS_CLK	PLL reference clock	Input	_	PD, ST
	SS_PLL_BYPASS	PLL bypass	Input	_	PD
PLL	SS_EXT_OSC_CONFIG	Oscillator config	Input	_	PD
FLL	SS_EXT_OSC_HS_MODE	Oscillator high-speed mode	Input	_	PD
	SS_XC0_BS[3:0]	Boot status (tile 0)	I/O	_	PU
	SS_XC1_BS[3:0]	Boot status (tile 1)	I/O	_	PU
	SS_TDI	Test data input	Input	_	PU, ST
	SS_TDO	Test data output	Output	_	PD
ITAC	SS_TMS	Test mode select	Input	_	PU, ST
JTAG	SS_TRST	Test reset input	Input	_	PU, ST
	SS_TCK	Test clock	Input	_	PU, ST
	SS_DEBUG	Multi-chip debug	I/O	_	PU
	X0D00	P1A <sup>0</sup>	I/O	_	PD <sub>S</sub> , R <sub>S</sub>
	X0D01	XOLA <sup>4i</sup> P1B <sup>0</sup>	I/O	_	PD <sub>S</sub> , R <sub>S</sub>
	X0D02	X0LA <sup>3i</sup> <sub>5b</sub> P4A <sup>0</sup> P8A <sup>0</sup> P16A <sup>0</sup> P32A <sup>20</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X0D03	X0LA <sup>2i</sup> <sub>5b</sub> P4A <sup>1</sup> P8A <sup>1</sup> P16A <sup>1</sup> P32A <sup>21</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X0D04	X0LA <sup>1i</sup> <sub>2b/5b</sub> P4B <sup>0</sup> P8A <sup>2</sup> P16A <sup>2</sup> P32A <sup>22</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X0D05	X0LA <sup>0i</sup> <sub>2b/5b</sub> P4B <sup>1</sup> P8A <sup>3</sup> P16A <sup>3</sup> P32A <sup>23</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X0D06	X0LA <sup>00</sup> <sub>2b/5b</sub> P4B <sup>2</sup> P8A <sup>4</sup> P16A <sup>4</sup> P32A <sup>24</sup>	I/O	_	PDs, Ru
	X0D07	X0LA <sup>1o</sup> <sub>2b/5b</sub> P4B <sup>3</sup> P8A <sup>5</sup> P16A <sup>5</sup> P32A <sup>25</sup>	I/O	_	PDs, Ru
	X0D08	X0LA <sup>20</sup> <sub>5b</sub> P4A <sup>2</sup> P8A <sup>6</sup> P16A <sup>6</sup> P32A <sup>26</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
Tile 0 I/O	X0D09	X0LA <sup>30</sup> <sub>5b</sub> P4A <sup>3</sup> P8A <sup>7</sup> P16A <sup>7</sup> P32A <sup>27</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X0D10	X0LA <sup>40</sup> <sub>5b</sub> P1C <sup>0</sup>	I/O	_	PD <sub>S</sub> , R <sub>S</sub>
	X0D11	P1D <sup>0</sup>	I/O	_	PD <sub>S</sub> , R <sub>S</sub>
	X0D12	P1E <sup>0</sup>	I/O	_	PDs, Ru
	X0D13	XOLB <sup>4i</sup> <sub>5b</sub> P1F <sup>0</sup>	I/O	_	PDs, Ru
	X0D14	X0LB <sup>3i</sup> <sub>5b</sub> P4C <sup>0</sup> P8B <sup>0</sup> P16A <sup>8</sup> P32A <sup>28</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X0D15	X0LB <sup>2i</sup> <sub>5b</sub> P4C <sup>1</sup> P8B <sup>1</sup> P16A <sup>9</sup> P32A <sup>29</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X0D16	X0LB <sup>1i</sup> <sub>2b/5b</sub> P4D <sup>0</sup> P8B <sup>2</sup> P16A <sup>10</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X0D17	X0LB <sup>0i</sup> <sub>2b/5b</sub> P4D <sup>1</sup> P8B <sup>3</sup> P16A <sup>11</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X0D18	X0LB <sup>00</sup> <sub>2b/5b</sub> P4D <sup>2</sup> P8B <sup>4</sup> P16A <sup>12</sup>	I/O	_	PDs, Ru



Module	Name	Function	Type	Active	Properties
	X0D19	X0LB <sup>10</sup> <sub>2b/5b</sub> P4D <sup>3</sup> P8B <sup>5</sup> P16A <sup>13</sup>	I/O	T -	PD <sub>S</sub> , R <sub>U</sub>
	X0D20	X0LB <sub>5b</sub> <sup>20</sup> P4C <sup>2</sup> P8B <sup>6</sup> P16A <sup>14</sup> P32A <sup>30</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X0D21	X0LB <sup>30</sup> <sub>5b</sub> P4C <sup>3</sup> P8B <sup>7</sup> P16A <sup>15</sup> P32A <sup>31</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X0D22	XOLB <sup>40</sup> <sub>5b</sub> PIG <sup>0</sup>	I/O	T —	PD <sub>S</sub> , R <sub>U</sub>
	X0D23	P1H <sup>0</sup>	I/O	T -	PD <sub>S</sub> , R <sub>U</sub>
	X0D24	P1I <sup>0</sup>	I/O	_	PDs
	X0D25	P1J <sup>0</sup>	I/O	_	PDs
	X0D26	P4E <sup>0</sup> P8C <sup>0</sup> P16B <sup>0</sup>	I/O	T —	PD <sub>S</sub> , R <sub>U</sub>
	X0D27	P4E <sup>1</sup> P8C <sup>1</sup> P16B <sup>1</sup>	I/O	T —	PD <sub>S</sub> , R <sub>U</sub>
	X0D28	P4F <sup>0</sup> P8C <sup>2</sup> P16B <sup>2</sup>	I/O	T —	PD <sub>S</sub> , R <sub>U</sub>
	X0D29	P4F <sup>1</sup> P8C <sup>3</sup> P16B <sup>3</sup>	I/O	T -	PD <sub>S</sub> , R <sub>U</sub>
	X0D30	P4F <sup>2</sup> P8C <sup>4</sup> P16B <sup>4</sup>	I/O	T -	PD <sub>S</sub> , R <sub>U</sub>
	X0D31	P4F <sup>3</sup> P8C <sup>5</sup> P16B <sup>5</sup>	I/O	T -	PD <sub>S</sub> , R <sub>U</sub>
	X0D32	P4E <sup>2</sup> P8C <sup>6</sup> P16B <sup>6</sup>	I/O	<b>—</b>	PD <sub>S</sub> , R <sub>U</sub>
	X0D33	P4E <sup>3</sup> P8C <sup>7</sup> P16B <sup>7</sup>	1/0	_	PD <sub>S</sub> , R <sub>U</sub>
	X0D34	P1K <sup>0</sup>	I/O	_	PDs
	X0D35	P1L <sup>0</sup>	1/0	_	PDs
	X0D36	P1M <sup>0</sup> P8D <sup>0</sup> P16B <sup>8</sup>	1/0	_	PDs
	X0D37	P1N <sup>0</sup> P8D <sup>1</sup> P16B <sup>9</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X0D38	P1O <sup>0</sup> P8D <sup>2</sup> P16B <sup>10</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X0D39	P1P <sup>0</sup> P8D <sup>3</sup> P16B <sup>11</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
Tile 0 I/O	X0D40	P8D <sup>4</sup> P16B <sup>12</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X0D41	P8D <sup>5</sup> P16B <sup>13</sup>	I/O	T -	PD <sub>S</sub> , R <sub>U</sub>
	X0D42	P8D <sup>6</sup> P16B <sup>14</sup>	I/O	T -	PD <sub>S</sub> , R <sub>U</sub>
	X0D43	P8D <sup>7</sup> P16B <sup>15</sup>	1/0	_	PU <sub>S</sub> , R <sub>U</sub>
	X0D49	X0LC <sup>4i</sup> P32A <sup>0</sup>	I/O	_	PDs
	X0D50	X0LC <sub>5b</sub> P32A <sup>1</sup>	I/O	_	PDs
	X0D51	X0LC <sub>5b</sub> P32A <sup>2</sup>	1/0	_	PDs
	X0D52	X0LC <sup>1i</sup> <sub>2b/5b</sub> P32A <sup>3</sup>	1/0	_	PDs
	X0D53	$X0LC_{2b/5b}^{0i}$ P32A <sup>4</sup>	1/0	_	PDs
	X0D54	X0LC <sup>0o</sup> <sub>2b/5b</sub> P32A <sup>5</sup>	I/O	_	PDs
	X0D55	X0LC <sup>10</sup> <sub>2b/5b</sub> P32A <sup>6</sup>	I/O	_	PDs
	X0D56	X0LC <sub>5b</sub> <sup>20</sup> P32A <sup>7</sup>	I/O	<b>†</b> –	PDs
	X0D57	X0LC <sub>5b</sub> P32A <sup>8</sup>	I/O	<u> </u>	PDs
	X0D58	X0LC <sup>40</sup> <sub>5b</sub> P32A <sup>9</sup>	1/0	_	PDs
	X0D61	X0LD <sup>4i</sup> <sub>5b</sub> P32A <sup>10</sup>	1/0	_	PDs
	X0D62	X0LD <sub>5b</sub> P32A <sup>11</sup>	I/O	_	PDs
	X0D63	X0LD <sup>2i</sup> <sub>5b</sub> P32A <sup>12</sup>	I/O	<b> </b>	PDs
	X0D64	X0LD <sup>1i</sup> <sub>2b/5b</sub> P32A <sup>13</sup>	I/O	-	PDs
	X0D65	X0LD <sup>0i</sup> <sub>2b/5b</sub> P32A <sup>14</sup>	1/0	<u> </u>	PDs
	X0D66	X0LD <sub>2b/5b</sub> P32A <sup>15</sup>	I/O	<del> </del>	PDs
	X0D67	X0LD <sub>2b/5b</sub> P32A <sup>16</sup>	I/O	<u> </u>	PDs
	X0D68	X0LD <sub>5b</sub> P32A <sup>17</sup>	1/0	<u> </u>	PDs



Module	Name	Function	Type	Active	Properties
Tile 0 I/O	X0D69	X0LD <sub>5b</sub> P32A <sup>18</sup>	I/O	_	PDs
1116 0 1/0	X0D70	X0LD <sub>5b</sub> P32A <sup>19</sup>	I/O	_	PDs
	X1D00	P1A <sup>0</sup>	I/O	_	PDs
	X1D01	X1LA <sup>40</sup> <sub>5b</sub> P1B <sup>0</sup>	I/O	T —	PDs
	X1D02	X1LA <sup>30</sup> <sub>5b</sub> P4A <sup>0</sup> P8A <sup>0</sup> P16A <sup>0</sup> P32A <sup>20</sup>	I/O	T —	PDs, Ru
	X1D03	X1LA <sup>20</sup> <sub>5b</sub> P4A <sup>1</sup> P8A <sup>1</sup> P16A <sup>1</sup> P32A <sup>21</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X1D04	X1LA <sup>1o</sup> <sub>2b/5b</sub> P4B <sup>0</sup> P8A <sup>2</sup> P16A <sup>2</sup> P32A <sup>22</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X1D05	X1LA <sup>0o</sup> <sub>2b/5b</sub> P4B <sup>1</sup> P8A <sup>3</sup> P16A <sup>3</sup> P32A <sup>23</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X1D06	X1LA <sup>0i</sup> <sub>2b/5b</sub> P4B <sup>2</sup> P8A <sup>4</sup> P16A <sup>4</sup> P32A <sup>24</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X1D07	X1LA <sup>1i</sup> <sub>2b/5b</sub> P4B <sup>3</sup> P8A <sup>5</sup> P16A <sup>5</sup> P32A <sup>25</sup>	I/O	T —	PD <sub>S</sub> , R <sub>U</sub>
	X1D08	X1LA <sup>2i</sup> <sub>5b</sub> P4A <sup>2</sup> P8A <sup>6</sup> P16A <sup>6</sup> P32A <sup>26</sup>	I/O	T —	PD <sub>S</sub> , R <sub>U</sub>
	X1D09	X1LA <sup>3i</sup> P4A <sup>3</sup> P8A <sup>7</sup> P16A <sup>7</sup> P32A <sup>27</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X1D10	X1LA <sup>4i</sup> <sub>5b</sub> P1C <sup>0</sup>	I/O	_	PDs
	X1D11	PID <sup>0</sup>	I/O	T -	PDs
	X1D12	P1E <sup>0</sup>	I/O	T —	PD <sub>S</sub> , R <sub>U</sub>
	X1D13	X1LB <sup>40</sup> <sub>5b</sub> P1F <sup>0</sup>	I/O	_	PDs, Ru
	X1D14	X1LB <sup>30</sup> <sub>5b</sub> P4C <sup>0</sup> P8B <sup>0</sup> P16A <sup>8</sup> P32A <sup>28</sup>	I/O	-	PD <sub>S</sub> , R <sub>U</sub>
	X1D15	X1LB <sub>5b</sub> P4C <sup>1</sup> P8B <sup>1</sup> P16A <sup>9</sup> P32A <sup>29</sup>	I/O	T -	PD <sub>S</sub> , R <sub>U</sub>
	X1D16	X1LB <sup>10</sup> <sub>2b/5b</sub> P4D <sup>0</sup> P8B <sup>2</sup> P16A <sup>10</sup>	I/O	T -	PD <sub>S</sub> , R <sub>U</sub>
	X1D17	X1LB <sup>0o</sup> <sub>2b/5b</sub> P4D <sup>1</sup> P8B <sup>3</sup> P16A <sup>11</sup>	I/O	T —	PD <sub>S</sub> , R <sub>U</sub>
	X1D18	X1LB <sup>0i</sup> <sub>2b/5b</sub> P4D <sup>2</sup> P8B <sup>4</sup> P16A <sup>12</sup>	I/O	T —	PD <sub>S</sub> , R <sub>U</sub>
	X1D19	X1LB <sup>1i</sup> <sub>2b/5b</sub> P4D <sup>3</sup> P8B <sup>5</sup> P16A <sup>13</sup>	I/O	T —	PDs, Ru
Tile 1 I/O	X1D20	X1LB <sup>2i</sup> <sub>5b</sub> P4C <sup>2</sup> P8B <sup>6</sup> P16A <sup>14</sup> P32A <sup>30</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X1D21	X1LB <sup>3i</sup> <sub>5b</sub> P4C <sup>3</sup> P8B <sup>7</sup> P16A <sup>15</sup> P32A <sup>31</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X1D22	X1LB <sup>4i</sup> <sub>5b</sub> P1G <sup>0</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X1D23	P1H <sup>0</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X1D24	P1I <sup>0</sup>	I/O	_	PDs
	X1D25	PIJ <sup>0</sup>	I/O	_	PDs
	X1D26	P4E <sup>0</sup> P8C <sup>0</sup> P16B <sup>0</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X1D27	P4E <sup>1</sup> P8C <sup>1</sup> P16B <sup>1</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X1D28	P4F <sup>0</sup> P8C <sup>2</sup> P16B <sup>2</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X1D29	P4F <sup>1</sup> P8C <sup>3</sup> P16B <sup>3</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X1D30	P4F <sup>2</sup> P8C <sup>4</sup> P16B <sup>4</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X1D31	P4F <sup>3</sup> P8C <sup>5</sup> P16B <sup>5</sup>	I/O	T —	PD <sub>S</sub> , R <sub>U</sub>
	X1D32	P4E <sup>2</sup> P8C <sup>6</sup> P16B <sup>6</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X1D33	P4E <sup>3</sup> P8C <sup>7</sup> P16B <sup>7</sup>	I/O	T -	PD <sub>S</sub> , R <sub>U</sub>
	X1D34	P1K <sup>0</sup>	I/O	T —	PD <sub>S</sub> , R <sub>U</sub>
	X1D35	P1L <sup>0</sup>	I/O	<u> </u>	PD <sub>S</sub> , R <sub>U</sub>
	X1D36	P1M <sup>0</sup> P8D <sup>0</sup> P16B <sup>8</sup>	I/O	-	PD <sub>S</sub> , R <sub>U</sub>
	X1D37	P1N <sup>0</sup> P8D <sup>1</sup> P16B <sup>9</sup>	I/O	-	PDs, Ru
	X1D38	P1O <sup>0</sup> P8D <sup>2</sup> P16B <sup>10</sup>	I/O	1-	PD <sub>S</sub> , R <sub>U</sub>
	X1D39	P1P <sup>0</sup> P8D <sup>3</sup> P16B <sup>11</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X1D40	P8D <sup>4</sup> P16B <sup>12</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>



Module	Name	Function	Type	Active	Properties
	X1D41	P8D <sup>5</sup> P16B <sup>13</sup>	I/O	<u> </u>	PD <sub>S</sub> , R <sub>U</sub>
	X1D42	P8D <sup>6</sup> P16B <sup>14</sup>	I/O	-	PD <sub>S</sub> , R <sub>U</sub>
	X1D43	P8D <sup>7</sup> P16B <sup>15</sup>	I/O	T -	PU <sub>S</sub> , R <sub>U</sub>
	X1D49	X1LC <sub>5b</sub> <sup>40</sup> P32A <sup>0</sup>	I/O	T —	PDs
	X1D50	X1LC <sub>5b</sub> P32A <sup>1</sup>	I/O	T -	PDs
	X1D51	X1LC <sub>5b</sub> <sup>20</sup> P32A <sup>2</sup>	I/O	_	PDs
	X1D52	X1LC <sup>10</sup> <sub>2b/5b</sub> P32A <sup>3</sup>	I/O	T -	PDs
	X1D53	X1LC <sup>00</sup> <sub>2b/5b</sub> P32A <sup>4</sup>	I/O	_	PDs
	X1D54	X1LC <sup>0i</sup> <sub>2b/5b</sub> P32A <sup>5</sup>	I/O	_	PDs
	X1D55	X1LC <sup>1i</sup> <sub>2b/5b</sub> P32A <sup>6</sup>	I/O	T —	PDs
	X1D56	X1LC <sub>5b</sub> P32A <sup>7</sup>	I/O	T -	PDs
Tile 1 I/O	X1D57	X1LC <sup>3i</sup> P32A <sup>8</sup>	I/O	T -	PDs
	X1D58	X1LC <sup>4i</sup> <sub>5b</sub> P32A <sup>9</sup>	I/O	T -	PDs
	X1D61	X1LD <sub>5b</sub> <sup>40</sup> P32A <sup>10</sup>	I/O	<b>—</b>	PDs
	X1D62	X1LD <sub>5b</sub> P32A <sup>11</sup>	I/O	<b>—</b>	PDs
	X1D63	X1LD <sub>5b</sub> <sup>20</sup> P32A <sup>12</sup>	I/O	T —	PDs
	X1D64	X1LD <sup>10</sup> <sub>2b/5b</sub> P32A <sup>13</sup>	I/O	_	PDs
	X1D65	X1LD <sup>00</sup> <sub>2b/5b</sub> P32A <sup>14</sup>	I/O	<u> </u>	PDs
	X1D66	X1LD <sup>0i</sup> <sub>2b/5b</sub> P32A <sup>15</sup>	I/O	T -	PDs
	X1D67	X1LD <sup>1i</sup> <sub>2b/5b</sub> P32A <sup>16</sup>	I/O	_	PDs
	X1D68	X1LD <sub>5b</sub> P32A <sup>17</sup>	I/O	<b>—</b>	PDs
	X1D69	X1LD <sub>5b</sub> P32A <sup>18</sup>	I/O	T —	PDs
	X1D70	X1LD <sup>4i</sup> P32A <sup>19</sup>	I/O	_	PDs
	X2D00	P1A <sup>0</sup>	I/O	_	PDs
	X2D01	X2LA <sup>4i</sup> P1B <sup>0</sup>	I/O	_	PDs
	X2D02	X2LA <sup>3i</sup> P4A <sup>0</sup> P8A <sup>0</sup> P16A <sup>0</sup> P32A <sup>20</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D03	X2LA <sup>2i</sup> <sub>5b</sub> P4A <sup>1</sup> P8A <sup>1</sup> P16A <sup>1</sup> P32A <sup>21</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D04	X2LA <sup>1i</sup> <sub>2b/5b</sub> P4B <sup>0</sup> P8A <sup>2</sup> P16A <sup>2</sup> P32A <sup>22</sup>	I/O	_	PDs, Ru
	X2D05	X2LA <sup>0i</sup> <sub>2b/5b</sub> P4B <sup>1</sup> P8A <sup>3</sup> P16A <sup>3</sup> P32A <sup>23</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D06	X2LA <sup>00</sup> <sub>2b/5b</sub> P4B <sup>2</sup> P8A <sup>4</sup> P16A <sup>4</sup> P32A <sup>24</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D07	X2LA <sup>1o</sup> <sub>2b/5b</sub> P4B <sup>3</sup> P8A <sup>5</sup> P16A <sup>5</sup> P32A <sup>25</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D08	X2LA <sub>5b</sub> <sup>20</sup> P4A <sup>2</sup> P8A <sup>6</sup> P16A <sup>6</sup> P32A <sup>26</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
Tile 2 I/O	X2D09	X2LA <sup>30</sup> <sub>5b</sub> P4A <sup>3</sup> P8A <sup>7</sup> P16A <sup>7</sup> P32A <sup>27</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
1116 2 1/0	X2D10	X2LA <sub>5b</sub> P1C <sup>0</sup>	I/O	_	PDs
	X2D11	PID <sup>0</sup>	I/O	_	PDs
	X2D12	P1E <sup>0</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D13	X2LB <sup>4i</sup> <sub>5b</sub> P1F <sup>0</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D14	X2LB <sup>3i</sup> <sub>5b</sub> P4C <sup>0</sup> P8B <sup>0</sup> P16A <sup>8</sup> P32A <sup>28</sup>	I/O	T —	PD <sub>S</sub> , R <sub>U</sub>
	X2D15	X2LB <sup>2i</sup> <sub>5b</sub> P4C <sup>1</sup> P8B <sup>1</sup> P16A <sup>9</sup> P32A <sup>29</sup>	I/O	1 –	PDs, Ru
	X2D16	X2LB <sup>1i</sup> <sub>2b/5b</sub> P4D <sup>0</sup> P8B <sup>2</sup> P16A <sup>10</sup>	I/O	1 –	PD <sub>S</sub> , R <sub>U</sub>
	X2D17	X2LB <sup>0i</sup> <sub>2b/5b</sub> P4D <sup>1</sup> P8B <sup>3</sup> P16A <sup>11</sup>	I/O	T -	PD <sub>S</sub> , R <sub>U</sub>
	X2D18	X2LB <sup>0o</sup> <sub>2b/5b</sub> P4D <sup>2</sup> P8B <sup>4</sup> P16A <sup>12</sup>	I/O	T -	PD <sub>S</sub> , R <sub>U</sub>
	X2D19	X2LB <sup>1o</sup> <sub>2b/5b</sub> P4D <sup>3</sup> P8B <sup>5</sup> P16A <sup>13</sup>	I/O	<b>—</b>	PD <sub>S</sub> , R <sub>U</sub>



Module	Name	Function	Type	Active	Properties
	X2D20	X2LB <sup>20</sup> <sub>5b</sub> P4C <sup>2</sup> P8B <sup>6</sup> P16A <sup>14</sup> P32A <sup>30</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D21	X2LB <sub>5b</sub> <sup>30</sup> P4C <sup>3</sup> P8B <sup>7</sup> P16A <sup>15</sup> P32A <sup>31</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D22	X2LB <sup>40</sup> <sub>5b</sub> P1G <sup>0</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D23	P1H <sup>0</sup>	I/O	_	PDs, Ru
	X2D24	P1I <sup>0</sup>	I/O	_	PDs
	X2D25	PIJ <sup>0</sup>	I/O	_	PDs
	X2D26	P4E <sup>0</sup> P8C <sup>0</sup> P16B <sup>0</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D27	P4E <sup>1</sup> P8C <sup>1</sup> P16B <sup>1</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D28	P4F <sup>0</sup> P8C <sup>2</sup> P16B <sup>2</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D29	P4F <sup>1</sup> P8C <sup>3</sup> P16B <sup>3</sup>	I/O	_	PDs, Ru
	X2D30	P4F <sup>2</sup> P8C <sup>4</sup> P16B <sup>4</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D31	P4F <sup>3</sup> P8C <sup>5</sup> P16B <sup>5</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D32	P4E <sup>2</sup> P8C <sup>6</sup> P16B <sup>6</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D33	P4E <sup>3</sup> P8C <sup>7</sup> P16B <sup>7</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D34	P1K <sup>0</sup>	I/O	_	PDs
	X2D35	P1L <sup>0</sup>	I/O	_	PDs
	X2D36	P1M <sup>0</sup> P8D <sup>0</sup> P16B <sup>8</sup>	I/O	_	PDs
	X2D37	P1N <sup>0</sup> P8D <sup>1</sup> P16B <sup>9</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D38	P1O <sup>0</sup> P8D <sup>2</sup> P16B <sup>10</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D39	P1P <sup>0</sup> P8D <sup>3</sup> P16B <sup>11</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D40	P8D <sup>4</sup> P16B <sup>12</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
Tile 2 I/O	X2D41	P8D <sup>5</sup> P16B <sup>13</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D42	P8D <sup>6</sup> P16B <sup>14</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X2D43	P8D <sup>7</sup> P16B <sup>15</sup>	I/O	_	PU <sub>S</sub> , R <sub>U</sub>
	X2D49	X2LC <sup>4i</sup> <sub>5b</sub> P32A <sup>0</sup>	I/O	_	PDs
	X2D50	X2LC <sub>5b</sub> <sup>3i</sup> P32A <sup>1</sup>	I/O	_	PDs
	X2D51	X2LC <sub>5b</sub> <sup>2i</sup> P32A <sup>2</sup>	I/O	_	PDs
	X2D52	X2LC <sup>1i</sup> <sub>2b/5b</sub> P32A <sup>3</sup>	I/O	_	PDs
	X2D53	X2LC <sup>0i</sup> <sub>2b/5b</sub> P32A <sup>4</sup>	I/O	_	PDs
	X2D54	X2LC <sup>00</sup> <sub>2b/5b</sub> P32A <sup>5</sup>	I/O	_	PDs
	X2D55	X2LC <sup>10</sup> <sub>2b/5b</sub> P32A <sup>6</sup>	I/O	_	PDs
	X2D56	X2LC <sub>5b</sub> <sup>20</sup> P32A <sup>7</sup>	I/O	_	PDs
	X2D57	X2LC <sub>5b</sub> <sup>30</sup> P32A <sup>8</sup>	I/O	_	PDs
	X2D58	X2LC <sup>40</sup> P32A <sup>9</sup>	I/O	_	PDs
	X2D61	X2LD <sup>4i</sup> <sub>5b</sub> P32A <sup>10</sup>	I/O	_	PDs
	X2D62	X2LD <sub>5b</sub> P32A <sup>11</sup>	I/O	_	PDs
	X2D63	X2LD <sup>2i</sup> <sub>5b</sub> P32A <sup>12</sup>	I/O	_	PDs
	X2D64	X2LD <sup>1i</sup> <sub>2b/5b</sub> P32A <sup>13</sup>	I/O	_	PDs
	X2D65	X2LD <sup>0i</sup> <sub>2b/5b</sub> P32A <sup>14</sup>	I/O	_	PDs
	X2D66	X2LD <sup>00</sup> <sub>2b/5b</sub> P32A <sup>15</sup>	I/O	_	PDs
	X2D67	X2LD <sup>10</sup> <sub>2b/5b</sub> P32A <sup>16</sup>	I/O	_	PDs
	X2D68	X2LD <sub>5b</sub> P32A <sup>17</sup>	I/O	_	PDs
	X2D69	X2LD <sub>5b</sub> P32A <sup>18</sup>	I/O	_	PDs



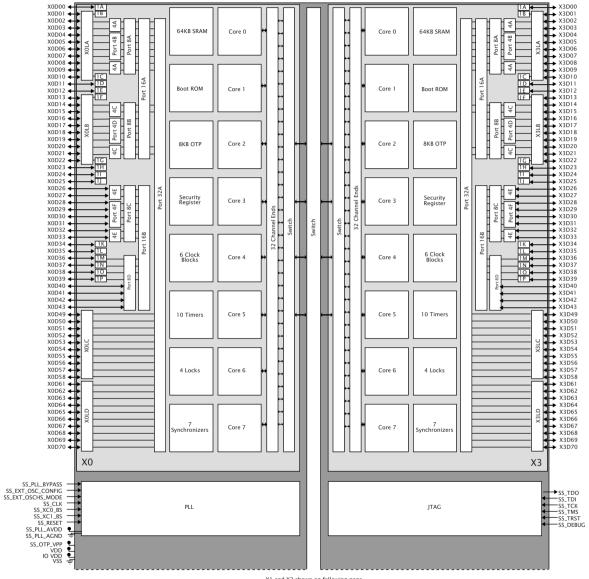
Module	Name	Function	Type	Active	Properties
Tile 2 I/O	X2D70	X2LD <sub>5b</sub> <sup>40</sup> P32A <sup>19</sup>	I/O	_	PDs
	X3D00	P1A <sup>0</sup>	I/O	_	PDs
	X3D01	X3LA <sub>5b</sub> P1B <sup>0</sup>	I/O	_	PDs
	X3D02	X3LA <sub>5b</sub> <sup>30</sup> P4A <sup>0</sup> P8A <sup>0</sup> P16A <sup>0</sup> P32A <sup>20</sup>	I/O	_	PDs, Ru
	X3D03	X3LA <sub>5b</sub> <sup>20</sup> P4A <sup>1</sup> P8A <sup>1</sup> P16A <sup>1</sup> P32A <sup>21</sup>	I/O	_	PDs, Ru
	X3D04	X3LA <sup>10</sup> <sub>2b/5b</sub> P4B <sup>0</sup> P8A <sup>2</sup> P16A <sup>2</sup> P32A <sup>22</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D05	X3LA <sup>00</sup> <sub>2b/5b</sub> P4B <sup>1</sup> P8A <sup>3</sup> P16A <sup>3</sup> P32A <sup>23</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D06	X3LA <sup>0i</sup> <sub>2b/5b</sub> P4B <sup>2</sup> P8A <sup>4</sup> P16A <sup>4</sup> P32A <sup>24</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D07	X3LA <sup>1i</sup> <sub>2b/5b</sub> P4B <sup>3</sup> P8A <sup>5</sup> P16A <sup>5</sup> P32A <sup>25</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D08	X3LA <sup>2i</sup> <sub>5b</sub> P4A <sup>2</sup> P8A <sup>6</sup> P16A <sup>6</sup> P32A <sup>26</sup>	I/O	_	PDs, Ru
	X3D09	X3LA <sup>3i</sup> P4A <sup>3</sup> P8A <sup>7</sup> P16A <sup>7</sup> P32A <sup>27</sup>	I/O	_	PDs, Ru
	X3D10	X3LA <sup>4i</sup> <sub>5b</sub> P1C <sup>0</sup>	I/O	_	PDs
	X3D11	P1D <sup>0</sup>	I/O	T —	PDs
	X3D12	P1E <sup>0</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D13	X3LB <sup>40</sup> <sub>5b</sub> P1F <sup>0</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D14	X3LB <sub>5b</sub> P4C <sup>0</sup> P8B <sup>0</sup> P16A <sup>8</sup> P32A <sup>28</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D15	X3LB <sup>2o</sup> <sub>5b</sub> P4C <sup>1</sup> P8B <sup>1</sup> P16A <sup>9</sup> P32A <sup>29</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D16	X3LB <sub>2b/5b</sub> P4D <sup>0</sup> P8B <sup>2</sup> P16A <sup>10</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D17	X3LB <sup>00</sup> <sub>2b/5b</sub> P4D <sup>1</sup> P8B <sup>3</sup> P16A <sup>11</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D18	X3LB <sup>0i</sup> <sub>2b/5b</sub> P4D <sup>2</sup> P8B <sup>4</sup> P16A <sup>12</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D19	X3LB <sup>1</sup> <sub>2b/5b</sub> P4D <sup>3</sup> P8B <sup>5</sup> P16A <sup>13</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
T:1- 2.1/0	X3D20	X3LB <sub>5b</sub> P4C <sup>2</sup> P8B <sup>6</sup> P16A <sup>14</sup> P32A <sup>30</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
Tile 3 I/O	X3D21	X3LB <sub>5b</sub> P4C <sup>3</sup> P8B <sup>7</sup> P16A <sup>15</sup> P32A <sup>31</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D22	X3LB <sup>4i</sup> <sub>5b</sub> P1G <sup>0</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D23	P1H <sup>0</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D24	P11 <sup>0</sup>	I/O	_	PDs
	X3D25	P1J <sup>0</sup>	I/O	_	PDs
	X3D26	P4E <sup>0</sup> P8C <sup>0</sup> P16B <sup>0</sup>	I/O	_	PDs, Ru
	X3D27	P4E <sup>1</sup> P8C <sup>1</sup> P16B <sup>1</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D28	P4F <sup>0</sup> P8C <sup>2</sup> P16B <sup>2</sup>	I/O	<u> </u>	PD <sub>S</sub> , R <sub>U</sub>
	X3D29	P4F <sup>1</sup> P8C <sup>3</sup> P16B <sup>3</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D30	P4F <sup>2</sup> P8C <sup>4</sup> P16B <sup>4</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D31	P4F <sup>3</sup> P8C <sup>5</sup> P16B <sup>5</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D32	P4E <sup>2</sup> P8C <sup>6</sup> P16B <sup>6</sup>	I/O	_	PDs, Ru
	X3D33	P4E <sup>3</sup> P8C <sup>7</sup> P16B <sup>7</sup>	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D34	P1K <sup>0</sup>	I/O	T —	PDs
	X3D35	P1L <sup>0</sup>	I/O	T —	PDs
	X3D36	P1M <sup>0</sup> P8D <sup>0</sup> P16B <sup>8</sup>	1/0	T —	PDs
	X3D37	P1N <sup>0</sup> P8D <sup>1</sup> P16B <sup>9</sup>	I/O	_	PDs, Ru
	X3D38	P1O <sup>0</sup> P8D <sup>2</sup> P16B <sup>10</sup>	1/0	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D39	P1P <sup>0</sup> P8D <sup>3</sup> P16B <sup>11</sup>	1/0	<u> </u>	PD <sub>S</sub> , R <sub>U</sub>
	X3D40	P8D <sup>4</sup> P16B <sup>12</sup>	1/0	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D41	P8D <sup>5</sup> P16B <sup>13</sup>	1/0	+	PD <sub>S</sub> , R <sub>U</sub>



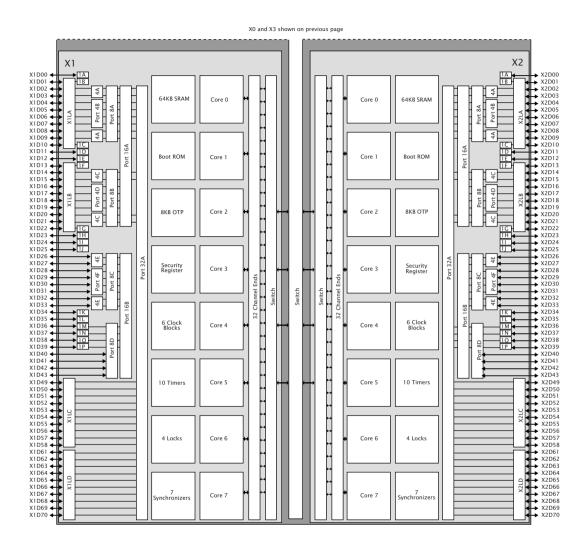
Module	Name	Function		Туре	Active	Properties
	X3D42	P8D <sup>6</sup> P16B	14	I/O	_	PD <sub>S</sub> , R <sub>U</sub>
	X3D43	P8D <sup>7</sup> P16B	15	I/O	_	PU <sub>S</sub> , R <sub>U</sub>
	X3D49	X3LC <sup>40</sup> <sub>5b</sub>	P32A <sup>0</sup>	I/O	_	PDs
	X3D50	X3LC <sub>5b</sub> <sup>30</sup>	P32A <sup>1</sup>	I/O	_	PDs
	X3D51	X3LC <sub>5b</sub> <sup>20</sup>	P32A <sup>2</sup>	I/O	_	PDs
	X3D52	X3LC <sup>1o</sup> <sub>2b/5b</sub>	P32A <sup>3</sup>	I/O	_	PDs
	X3D53	X3LC <sup>0o</sup> <sub>2b/5b</sub>	P32A <sup>4</sup>	I/O	_	PDs
	X3D54	X3LC <sup>0i</sup> <sub>2b/5b</sub>	P32A <sup>5</sup>	I/O	_	PDs
	X3D55	X3LC <sup>1i</sup> <sub>2b/5b</sub>	P32A <sup>6</sup>	I/O	_	PDs
	X3D56	X3LC <sup>2i</sup> <sub>5b</sub>	P32A <sup>7</sup>	I/O	_	PDs
Tile 3 I/O	X3D57	X3LC <sup>3i</sup>	P32A <sup>8</sup>	I/O	_	PDs
THE 3 1/O	X3D58	X3LC <sup>4i</sup> <sub>5b</sub>	P32A <sup>9</sup>	I/O	_	PDs
	X3D61	X3LD <sup>40</sup> <sub>5b</sub>	P32A <sup>10</sup>	I/O	_	PDs
	X3D62	X3LD <sub>5b</sub> <sup>30</sup>	P32A <sup>11</sup>	I/O	_	PDs
	X3D63	X3LD <sub>5b</sub> <sup>2o</sup>	P32A <sup>12</sup>	I/O	_	PDs
	X3D64	X3LD <sup>1o</sup> <sub>2b/5b</sub>	P32A <sup>13</sup>	I/O	_	PDs
	X3D65	X3LD <sup>00</sup> <sub>2h/5h</sub>	P32A <sup>14</sup>	I/O	_	PDs
	X3D66	X3LD <sup>0i</sup> <sub>2b/5b</sub>	P32A <sup>15</sup>	I/O	_	PDs
	X3D67	X3LD <sup>1i</sup> <sub>2b/5b</sub>	P32A <sup>16</sup>	I/O	_	PDs
	X3D68	X3LD <sup>2i</sup> <sub>5b</sub>	P32A <sup>17</sup>	I/O	_	PDs
	X3D69	X3LD <sup>3i</sup> <sub>5b</sub>	P32A <sup>18</sup>	I/O	_	PDs
	X3D70	X3LD <sup>4i</sup> <sub>5b</sub>	P32A <sup>19</sup>	I/O	_	PDs
	SS_PLL_LOCK	Reserved (do not connect)		Output	_	PD
	SS_BYPASS_PLL_LOCK	Reserved (tie to VSS)		Input	_	PD
	SS_PLL_TEST	Reserved (do not connect)		Input	_	
	SS_OTP_VREF	Reserved (do not connect)		Output	_	
Reserved	SS_OTP_PWR_UP	Reserved (do not connect)	Output	_		
	SS_TEST_ENA	Reserved (tie to VSS)		Input	_	PD
	SS_XC_CFG[1:0]	Reserved (tie to VSS)		Input	_	PD
	SS_RESERVED	Reserved (do not connect)		Output	_	
	NC	Not connected		I/O	_	



## 4 Block Diagram



X1 and X2 shown on following page





## 5 Product Overview

The XMOS XS1-G04B-FB512 is a powerful device that provides a simple design process and highly-flexible solution to many applications. The device consists of four xCORE Tiles, each comprising a flexible multicore microcontroller with tightly integrated I/O and on-chip memory. The processors run mutiple tasks simultaneously using logical cores, each of which is guaranteed a slice of processing power and can execute computational code, control software and I/O interfaces. Logical cores use channels to exchange data within a tile or across tiles. The tiles are connected via an integrated switch network, which uses a proprietary physical layer protocol, and which can also be used to add additional resources to a design. The I/O pins are driven using intelligent ports that can serialize data, interpret strobe signals and wait for scheduled times or events, making the device ideal for real-time control applications.

The device can be configured using a set of software components that are rapidly customized and composed. XMOS provides source code libraries for many standard components. The device can be programmed using high-level languages such as C/C++ and XMOS-originated extensions to C, called XC, that simplify the control over concurrency, I/O and time.

The XMOS toolchain includes compilers, a simulator, debugger and static timing analyzer. The combination of real-time software, a compiler and timing analyzer enables the programmer to close timings on components of the design without a detailed understanding of the hardware characteristics.

## 5.1 Logical cores, Synchronizers and Locks

Each xCORE Tile has up to eight active logical cores, which issue instructions down a shared four-stage pipeline. Instructions from the active cores are issued round-robin. If up to four logical cores are active, each core is allocated a quarter of the processing cycles. If more than four logical cores are active, each core is allocated at least 1/n cycles (for n cores). Figure 1 shows the guaranteed core performance depending on the number of cores used.

Figure 1: Core performance

Speed Grade	Minimum MIPS per core (for <i>n</i> cores)							
	1	2	3	4	5	6	7	8
400 MHz	100	100	100	100	80	67	57	50

There is no way that the performance of a logical core can be reduced below these predicted levels. Because cores may be delayed on I/O, however, their unused processing cycles can be taken by other cores. This means that for more than four logical cores, the performance of each core is often higher than the predicted minimum.

### 5.2 Channel Ends, Links and Switch

Logical cores communicate using point-to-point connections formed between two channel ends. Between tiles, channel communications are implemented over



xConnect Links and routed through switches. The links operate in either 2bit/direction or 5bit/direction mode, depending on the amount of bandwidth required. Circuit switched, streaming and packet switched data can both be supported efficiently. Streams provide the fastest possible data rates between xCORE Tiles (up to 250 MBit/s), but each stream requires a single link to be reserved between switches on two tiles. All packet communications can be multiplexed onto a single link. A total of eight 5bit links are available between every pair of cores.

Information on the supported routing topologies that can be used to connect multiple devices together can be found in the XS1-G Link Performance and Design Guide, X7561.

#### 5.3 Ports and Clock Blocks

Ports provide an interface between the logical cores and I/O pins. All pins of a port provide either output or input. Signals in different directions cannot be mapped onto the same port.

The operation of each port is synchronized to a clock block. A clock block can be connected to an external clock input, or it can be run from the divided reference clock. A clock block can also output its signal to a pin. On reset, each port is connected to clock block 0, which runs from the xCORE Tile reference clock.

The ports and links are multiplexed, allowing the pins to be configured for use by ports of different widths or links. If an xConnect Link is enabled, the pins of the underlying ports are disabled. If a port is enabled, it overrules ports with higher widths that share the same pins. The pins on the wider port that are not shared remain available for use when the narrower port is enabled. Ports always operate at their specified width, even if they share pins with another port.

#### 5.4 Timers

Timers are 32-bit counters that are relative to the xCORE Tile reference clock. A timer is defined to tick every 10 ns. This value is derived from the reference clock, which is configured to tick at 100 MHz by default.

#### 5.5 PLL

The PLL is used to generate all on-chip clocks. SS\_CLK is the reference clock input. It should be supplied with a clock with monotonic rising edges and should be stable before SS\_RESET is taken high.

Many standard clock frequencies can be used with appropriate settings configured into the PLL. At boot time, before the PLL can be reconfigured, the PLL multiplier is set using the pins specified in the table in Figure 2. The PLL increases the clock frequency to the tile frequency used to run the processor data path and the switch.



Clock frequencies of betweeen 20 MHz and 25 MHz are not supported.

Further details on configuring the clock can be found in the XS1-G Clock Frequency Control document. X3221.



SS_PLL_	SS_EXT_OSC_	SS_EXT_OSC_	PLL multi-	CLK Input	Boot Freq-
BYPASS	CONFIG	HS_MODE	plier ratio	(MHz)	ency (MHz)
0	0	X	20	12.5-20	250-400
0	1	0	5	25-50	125-250
0	1	1	2.5	50-100	125-250
1	Х	Х	0.5	<100	<50

Figure 2: PLL boot modes

#### 5.6 Boot ROM

The boot procedure is illustrated in Figure 3. If bit 5 of the security register is set (*see* §5.7.1), the device boots from OTP. Otherwise, SS\_XCO\_BS[1:0] controls the boot source.

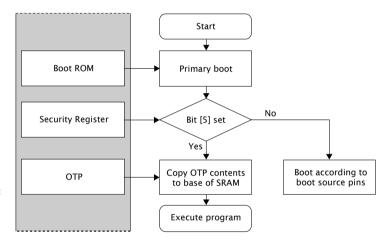


Figure 3: Boot procedure

SS\_XCO\_BS[1:0] operates as an input prior to the de-assertion of SS\_RESET. The device latches the value driven onto these pins on the rising edge (de-assertion) of SS\_RESET. The value driven should be static and configured using pullup or pulldown resistors, as the device drives the boot status on these pins after reset. The value configured on these two pins defines the boot mode, as described in Figure 4.

After reset is complete,  $SS_XCO_BS[3:0]$  becomes an output and indicates the boot mode, as described in Figure 5.  $SS_XC1_BS[3:0]$  also becomes an output after reset, indicating the tile 1 boot mode.  $SS_XCn_BS[3]$  indicates that the boot on tile n has completed.

#### 5.7 OTP

Each xCORE Tile integrates 8 KB one-time programmable (OTP) memory along with a security register that configures system wide security features. The OTP holds data in 2k rows  $\times$  32-bit configuration which can be used to implement secure



SS_XC0_BS[1]	SS_XC0_BS[0]	Boot Mo	Boot Mode				
0	0	Reserved	d				
0	1	Reserved	Reserved				
			s from SPI end 0 via	, X1X3 from X0			
_	_	Pin <sup>A</sup>	Signal	Description			
1	0	X0D00	MISO	Master In Slave Out			
		X0D01	SS	Slave Select			
		X0D10	SCLK	Clock			
		X0D11	Master Out Slave In				
1	1	None: Device waits to be booted via ITAG					

Figure 4: Boot source pins

A The pins used for SPI boot are hardcoded in the boot ROM and cannot be changed. An SPI boot program can be burned into OTP and used at any time.

Figure 5: Boot mode indication pins

SS_XCn_BS[2]	SS_XCn_BS[1]	SS_XCn_BS[0]	Boot Mode
0	0	1	Xn booted from OTP
0	1	0	Reserved
0	1	1	Xn booted from chanend 0
1	0	0	Xn booted from SPI
1	0	1	Xn booted from JTAG

bootloaders and store encryption keys. Data for the security register is loaded from the OTP on power up. All additional data in OTP is copied from the OTP to SRAM and executed first on the processor.

#### 5.7.1 Security Register

The security register enables the following security features:

- ▶ Secure Boot: The xCORE Tile is forced to boot from address 0 of the OTP, allowing the xCORE Tile boot ROM to be bypassed (see §5.6). This feature can be used to implement a secure bootloader which loads an encrypted image from external flash, decrypts and CRC checks it with the processor, and discontinues the boot process if the decryption or CRC check fails. XMOS provides a default secure bootloader that can be written to the OTP along with secret decryption keys.
- Disable JTAG: The JTAG interface is disabled, making it impossible for the tile state or memory content to be accessed via the JTAG interface.
- ▶ Disable Link access: Other tiles are forbidden access to the processor state via the system switch.



Disabling both JTAG and Link access transforms an xCORE Tile into a "secure island" with other tiles free for non-secure user application code.

- ▶ **Disable Global Debug access**: Disables access to the SS\_DEBUG pin.
- ▶ OTP Master and Sector Lock: Further access to the OTP is prevented by setting the master lock. Locks can also be applied to each of the four OTP sectors individually.

These security features provide a strong level of protection and are sufficient for providing strong IP security.

### **5.8 SRAM**

Each xCORE Tile integrates a single 64 KB SRAM bank for both instructions and data. All internal memory is 32 bits wide, and instructions are either 16-bit or 32-bit. Byte (8-bit), half-word (16-bit) or word (32-bit) accesses are supported and are executed within one tile clock cycle. There is no dedicated external memory interface, although data memory can be expanded through appropriate use of the ports.

## **5.9 JTAG**

The JTAG module can be used for loading programs, boundary scan testing, incircuit source-level debugging and programming the OTP memory.

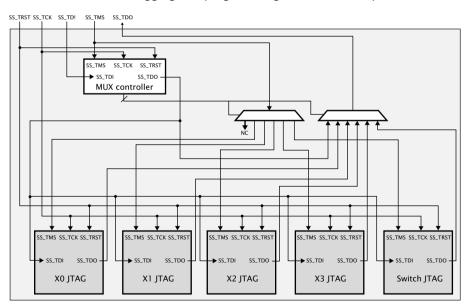


Figure 6: JTAG chain structure

The JTAG chain structure is illustrated in Figure 6. Directly after reset, two TAP controllers are present in the JTAG chain for each xCORE Tile: the boundary scan



TAP and the chip TAP. The boundary scan TAP is a standard 1149.1 compliant TAP that can be used for boundary scan of the I/O pins. The chip TAP provides access into the xCORE Tile, switch and OTP for loading code and debugging.

The SS\_TRST pin must be asserted low during and after power up for 100 ns. If JTAG is not required, the SS\_TRST pin can be tied to ground to hold the JTAG module in reset.

The JTAG device identification register can be read by using the IDCODE instruction. Its contents are specified in Figure 7.

Figure 7: IDCODE return value

В	it3	1											D	evice	e Ide	ntifi	catio	n R	egist	er											В	it0
	٧	/ers	ion								Pa	rt N	umb	er										Man	ufac	ture	r Ide	ntity	,			1
0		0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	1	0	0	0	1	1	0	0	0	1	1	0	0	1	1
		C	)			(	)				1			(	)			-	1			(	5				3			3	3	

The JTAG usercode register can be read by using the USERCODE instruction. Its contents are specified in Figure 8. The OTP User ID field is read from bits [22:31] of the security register on xCORE Tile 0 (all zero on unprogrammed devices).

Figure 8: USERCODE return value

Bi	t3	1												- 1	User	code	Reg	giste	r												В	it0
				0	TP U	lser	ID					Unu	ısed									Silic	on I	Revis	ion							
0		0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
		0	)			(	0			(	0				2				8				)			(	)				)	

## 5.10 Power Supplies

The device has the following types of power supply pins:

- VDD pins for the xCORE Tile tile
- ▶ IO VDD pins for the I/O lines
- SS\_PLL\_AVDD pins for the PLL
- SS\_OTP\_VPP pins for faster programming the OTP (optional)

Several pins of each type are provided to minimize the effect of inductance within the package, all of which must be connected. The power supplies must be brought up monotonically and input voltages must not exceed specification at any time.

The VDD supply must ramp from 0 V to its final value within 10 ms to ensure correct startup.

The IO VDD supply must ramp to its final value before VDD reaches 0.4 V.

The SS\_PLL\_AVDD supply should be separated from the other noisier supplies on the board. The PLL requires a very clean power supply, and a low pass filter (for example, a  $4.7\,\Omega$  resistor and 1  $\mu$ F multi-layer ceramic capacitor) is recommended on this pin.

The SS\_OTP\_VPP supply can be optionally provided for faster OTP programming times, otherwise an internal charge pump is used.



The following ground pins are provided:

- ▶ PLL AGND for PLL AVDD
- ► GND for all other supplies

All ground pins must be connected directly to the board ground.

The VDD and IO VDD supplies should be decoupled close to the chip by several 100 nF low inductance multi-layer ceramic capacitors between the supplies and GND (for example, 4x100nF 0402 low inductance MLCCs per supply rail). The ground side of the decoupling capacitors should have as short a path back to the GND pins as possible. A bulk decoupling capacitor of at least 10 uF should be placed on each of these supplies.

SS\_RESET is an active-low asynchronous-assertion global reset signal. Following a reset, the PLL re-establishes lock after which the device boots up according to the boot mode (see §5.6). SS\_RESET and must be asserted low during and after power up for 100 ns.



## 6 DC and Switching Characteristics

## 6.1 Operating Conditions

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
VDD	Tile DC supply voltage	0.95	1.00	1.05	V	
VDDIO	I/O supply voltage	3.00	3.30	3.60	V	
PLL_AVDD	PLL analog supply	0.95	1.00	1.05	V	
OTP_VPP	OTP external programming voltage (optional program only)	6.18	6.50	6.83	V	
CI	xCORE Tile I/O load capacitance			25	pF	
Та	Ambient operating temperature (Commercial)	0		70	°C	
	Ambient operating temperature (Industrial)	-40		85	°C	
Tj	Junction temperature			125	°C	
Tstg	Storage temperature	-65		150	°C	

Figure 9: Operating conditions

## 6.2 DC Characteristics

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
V(IH)	Input high voltage	2.00		5.50	V	A, B
V(IL)	Input low voltage	-0.30		0.80	V	A, B
V(OH)	Output high voltage	2.40			V	A, B
V(OL)	Output low voltage			0.40	V	A, B
R(PU)	Pull-up resistance		100K		Ω	A, C

Figure 10: DC characteristics

- A All pins except power supply pins.
- B Internal pull-up resistors are fitter to general-purpose I/O pins.
- C Use for unused I/O only. The internal pull-up resistor is not recommended as a substitute for an external pull-up resistor.

## 6.3 ESD Stress Voltage

Figure 11: ESD stress voltage

Symbo	Parameter	MIN	TYP	MAX	UNITS	Notes
HBM	Human body model	-2.00		2.00	KV	
MM	Machine model	-200		200	V	



## 6.4 Reset Timing

Figure 12:

Symbol	Parameters	MIN	TYP	MAX	UNITS	Notes
T(RST)	Reset pulse width	100			ns	
T(PLLLOCK)	PLL lock			1	ms	
T(INIT)	Initialization time			<100	μs	Α

A Shows the time taken to start booting after SS\_RESET has gone high.

## 6.5 Quiescent Current

Figure 13: Quiescent current

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
I(DDCQ)	Quiescent VDD current		120		mA	
I(PLLQ)	Quiescent PLL current		4		mA	

## 6.6 Power Consumption

Figure 14: xCORE Tile currents

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
PD	Tile power dissipation		1.6		Watts	A, B, C, D

- A Use for budgetary purposes only.
- B Assumes typical tile and I/O voltages operating at 400 MHz with nominal activity on all tiles.
- C PD(TYP) value is the usage power consumption under typical operating conditions.
- D PD(TYP) value includes quiescent current.



The tile power consumption of the device is highly application dependent and should be used for budgetary purposes only.

More detailed power analysis can be found in the XS1-G Power Consumption document, X7561.

### 6.7 Clock

Figure 15: Clock

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
f	Frequency	12.5	20	20	MHz	
SR	Slew rate	1		2	ns	
f(MAX)	Processor clock frequency			400	MHz	

Further details can be found in the XS1-G Clock Frequency Control document, X3221.



## 6.8 xCORE Tile I/O AC Characteristics

Figure 16: I/O AC characteristics

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
T(XOVALID)	Input data valid window	8			ns	
T(XOINVALID)	Output data invalid window	9			ns	
T(XIFMAX)	Rate at which data can be sampled with respect to an external clock			60	MHz	

The input valid window parameter relates to the capability of the device to capture data input to the chip with respect to an external clock source. It is calculated as the sum of the input setup time and input hold time with respect to the external clock as measured at the pins. The output invalid window specifies the time for which an output is invalid with respect to the external clock. Note that these parameters are specified as a window rather than absolute numbers since the device provides functionality to delay the incoming clock with respect to the incoming data.

Information on interfacing to high-speed synchronous interfaces can be found in the XS1 Port I/O Timing document, X5821.

### 6.9 xConnect Link Performance

Figure 17: Link performance

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
B(2blinkP)	2b link bandwidth (packetized)			87	MBit/s	A, B
B(5blinkP)	5b link bandwidth (packetized)			217	MBit/s	A, B
B(2blinkS)	2b link bandwidth (streaming)			100	MBit/s	В
B(5blinkS)	5b link bandwidth (streaming)			250	MBit/s	В

A Assumes 32-byte packet in 3-byte header mode. Actual performance depends on size of the header and payload.

The asynchronous nature of links means that the relative phasing of SS\_CLK clocks is not important in a multi-clock system, providing each meets the required stability criteria.

## 6.10 JTAG Timing

Figure 18: JTAG timing

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
T(TCK)	TCK period	30			ns	
T(SETUP)	TDO to TCK setup time	5			ns	Α
T(HOLD)	TDO to TCK hold time			10	ns	Α
T(DELAY)	TCK to output delay			15	ns	В

A Timing applies to SS\_TMS, SS\_TRST and SS\_TDI inputs.

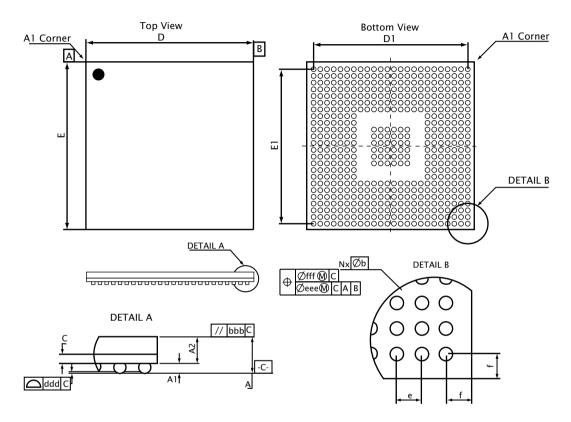
All JTAG operations are synchronous to SS\_TCK apart from the global asynchronous reset SS\_TRST.



B 7.5 ns symbol time.

B Timing applies to SS\_TDO output.

## 7 Package Information



Dimensional Ref			
REF	Min	Nom	Max
Α			1.6
A1	0.27		
A2	1.02	1.06	1.1
D		20.0	
D1		18.4	
E		20.0	
E1		18.4	
b		0.5	
С	0.32	0.36	0.40
е		0.8	
f		0.8	
m		24	
n		512	

Dimensional Tol		
aaa 0.15		
bbb	0.10	
ddd	0.20	
eee	0.15	
fff	0.08	

Notes
-------

- All dimensions in mm.
- 2. 'e' represents the basic solder ball pitch.
- 'm' represents the basic solder ball matrix size.
  'n' is the number of attached solder balls.
- 'b' is measurable at the maximum solder ball diameter parallel the primary datum – C –.
- 5. Dimension 'aaa' is measured parallel to primary datum C –.
- Primary datum C and the seating plane are defined by the spherical crowns of the solder halls
- 7. The package surface shall be matte finish charmilles 24 to 27.
- 8. The over package thickness 'A' already considers collapse balls.



## 7.1 Part Marking

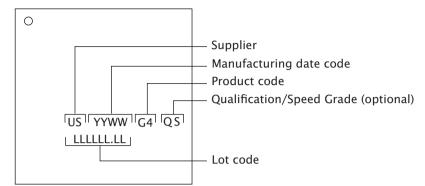


Figure 19: Part marking scheme

## 8 Ordering Information

Figure 20:
Orderable
part numbers

Product Code	Qualification	Speed Grade
XS1-G04B-FB512-C4	Commercial	400 MHz
XS1-G04B-FB512-I4	Industrial	400 MHz

## 9 Development Tools

XMOS provides a comprehensive suite of development tools. Source files, timing scripts and a board design file are input to the compiler toolchain which produces a binary executable. This executable file can be simulated, loaded onto the device and debugged over JTAG, programmed into flash memory on the board or written to OTP memory on the device. The tools can also encrypt the flash image and write the decrpytion key securely to OTP memory.

The tools can be driven from either a graphical development environment or the command line and are supported on Windows, Linux and MacOS X. The tools are available at no cost from xmos.com/downloads. Information on using the tools is provided in a separate user guide, X1013.

## 10 Addendum: XMOS USB Interface

XMOS provides a low-level USB interface for connecting the device to a USB transceiver using the UTMI+ Low Pin Interface (ULPI). The ULPI signals must be connected to the pins named in Figure 21. Note also that some ports on the same tile are used internally and are not available for use when the USB driver is active (they are available otherwise).



Pin	Signal
XnD02	
XnD03	
XnD04	l
XnD05	Unavailable when USB
XnD06	active
XnD07	
XnD08	
XnD09	

Pin	Signal
X <i>n</i> D12	ULPI_STP
X <i>n</i> D13	ULPI_NXT
XnD14	ULPI_DATA[0]
X <i>n</i> D15	ULPI_DATA[1]
X <i>n</i> D16	ULPI_DATA[2]
X <i>n</i> D17	ULPI_DATA[3]
XnD18	ULPI_DATA[4]
XnD19	ULPI_DATA[5]
XnD20	ULPI_DATA[6]
XnD21	ULPI_DATA[7]
XnD22	ULPI_DIR
X <i>n</i> D23	ULPI_CLK

Pin	Signal
XnD26	
XnD27	
XnD28	
XnD29	Unavailable when USB
XnD30	active
X <i>n</i> D31	
XnD32	
XnD33	

X <i>n</i> D37	
X <i>n</i> D38	
X <i>n</i> D39	Unavailable
XnD40	when USB
XnD41	active
XnD42	
XnD43	

Figure 21: ULPI signals provided by the XMOS USB driver

## 11 Associated Design Documentation

Document Title	Information	Document Number
Device Package User Guide	Land pattern, solder paste, ground recommendations	X4979
Estimating Power Consumption For XS1-G Devices	Power consumption	X6037
Programming XC on XMOS Devices	Timers, ports, clocks, cores and channels	X9577
XMOS Tools User Guide	Compilers, assembler and linker/mapper	X1013
	Timing analyzer and debugger	
	Flash and OTP programming utilities	

► Example schematic diagrams detailing minimal system configurations are available from http://www.xmos.com/support/silicon.



## 12 Related Documentation

Document Title	Information	Document Number
The XMOS XS1 Architecture	ISA manual	X7879
XS1 Port I/O Timing	Port timings	X5821
XS1-G System Specification	Link, switch and system information	X2725
XS1-G Link Performance and Design Guidelines	Link timings	X7561
XS1-G Clock Frequency Control	Advanced clock control	X3221

## 13 Revision History

The page numbers in this section refer to this document.

### Rev. X1066I-10/12

- 1. Renamed XCore to xCORE Tile, and Thread to Core.
- 2. Instruction description updated page 2.

### Rev. X1066H-05/12-B

1. Block diagram updated: pins listed sequentially, 4-bit ports updated - page 11.

#### Rev. X1066G-05/12

- 1. SS\_XCO\_CFG and SS\_PLL\_BYPASS tied to VSS on page 4.
- 2. OTP section updated and moved before SRAM on page 17.

### Rev. X1066F-03/12

- 1. Removed "Volatile" from Memory description on page 2.
- 2. Updated 32-bit port connection in block diagram on page 11.

#### Rev. X1066E-10/11

1. Updated "Part Marking" on page 24.

## Rev. X1066D-05/11-B

- 1. Revised format.
- 2. Standard XMOS Link format XnLn on page 4.

#### Rev. X1066C-01/11

- 1. Replaced "Port Pin Table" with "Signal Description" on page 4.
- 2. Updated "ULPI" on page 24 with set of disabled signals.
- 3. Removed "Device Configuration".
- 4. Added "Associated Design Documentation" on page 25.
- 5. Clock frequencies of betweeen 20 MHz and 25 MHz are **not** supported.
- 6. Removed documentation of numerous JTAG commands, which were incorrect.
- 7. Updated Figure 10 in "DC Characteristics" on page 20 by removing rows for I(OH) and I(OL).
- 8. Updated Figure 17 in "xConnect Link Performance' on page 22 by removing rows for B(2link) and B(5link), and adding rows for B(2linkP), B(5linkP), B(2linkS) and B(5linkS).
- 9. Renamed IO VSS signals to VSS.

#### Rev. X1066B-06/10

- 1. Updated pin list on page 4.
- 2. Updated "Power Consumption" on page 21.



Rev. X1066A-12/09

1. Revised format.



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